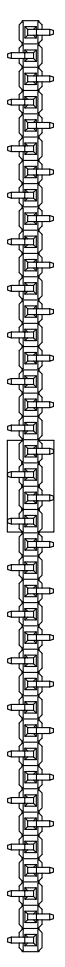
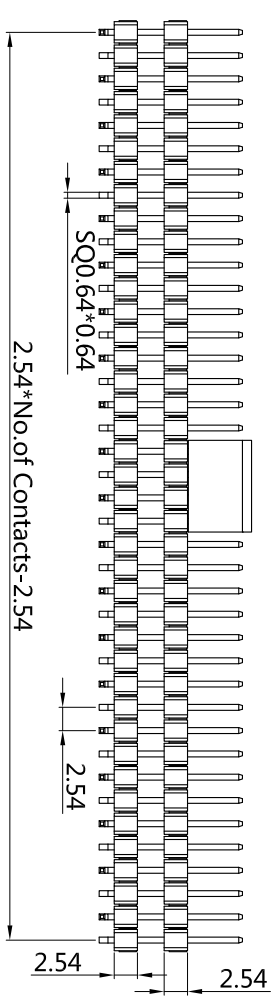
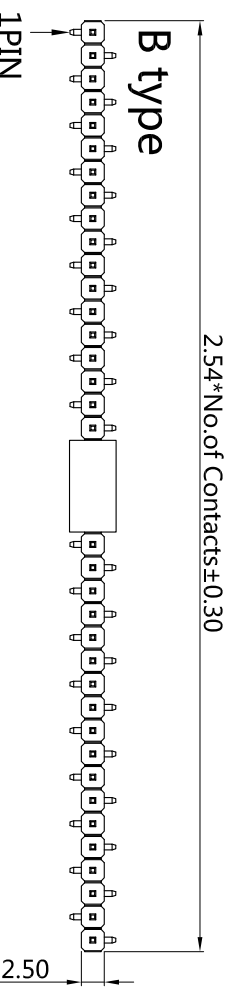


A



(RoHS Compliant)

H1 X 25 - 1 XX DB BK X D00 E

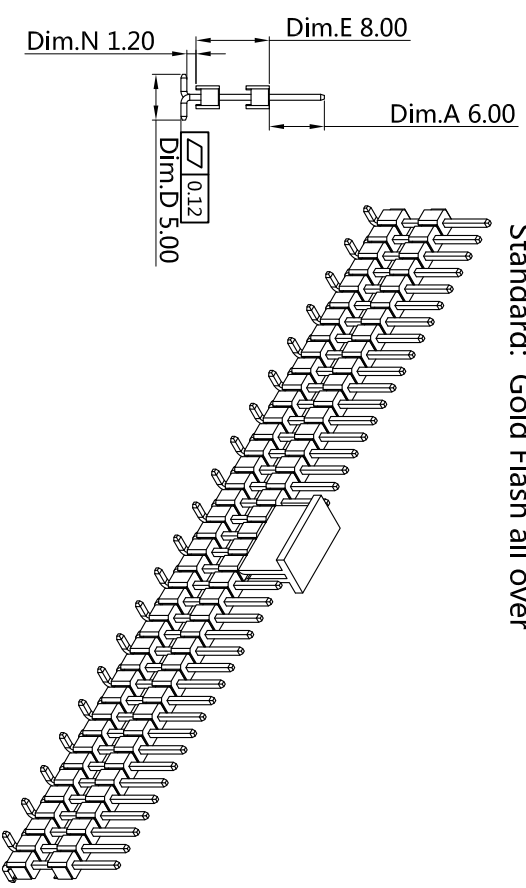
1. Insulator material: 5. Contact Plated:

A=PBT N=PA6T T=Matte Tin over Nickel
 L=LCP P=PA9T W=Matte Tin over nickel
 2. Circuits:1-40 PIN Y=Bright Tin over Nickel
 3. Tail Style: F=Gold Flash, Matte Tin 100μ"
 DA=SMT A Type A=Gold 3μ"
 DB=SMT B Type L=Gold 10μ"
 4. Color: C = ordinary gold plating M=Gold 15μ"
 BK=Black D = Gold 5μ" V=Gold 30μ"

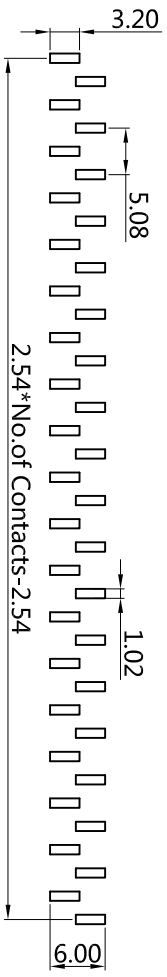
6.Special Options

7. Packing:
 I=Gold 1μ"
 E=Gold 5μ"
 Matte Tin 100μ"
 G=Gold 10μ"
 J=Gold 10μ"
 Matte Tin 100μ"
 L=Gold 15μ"
 M=Gold 15μ"
 Matte Tin 100μ"
 U=Gold 30μ"
 Matte Tin 100μ"

Current Rating: 3 Amps
 Insulator Resistance: 1000 Megohms min
 Dielectric Withstanding: AC 500V
 Contact Resistance: 20mΩ MAX
 Operation Temperature: -40~+105°C
 Max processing temp: 230°C for 60seconds
 Max processing temp: 260°C for 10seconds
 Contact Material: Brass
 Insulator material: Standard: Polyester,UL 94V-0
 Standard: PA6T
 Finish: Tin Gold Plated
 Standard: Gold Flash all over



Recommended P.C. Board
 SMD Layout



<p>东莞市震升电子有限公司 DONG GUAN ZHEN SHENG ELECTRONICS CO., LTD</p>		PART NO.		H1X25-1XXDBKX000E		.X		.XX		.XXX	
BOM		DRAWING NO		ZS-00183-P		EDITION:A1		ITEM: H1		SCALE:1:1	
1:H1N25-140BKHOCL		DRAWN BY		Deng Jin Quan		2021-12-26		UNIT:M:M			
2:SQ0064-17.7-X-C12		APPROVAL BY		Chen xiao guang		2021-12-28					
3:											
TEL:0769-85305015 FAX:0769-85845060											